

COMPARITIVE STUDY OF VIBRATION IN SCREW AND SPRING SUPPORTED PRINTED CIRCUIT BOARD



A PROJECT REPORT

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BONAFIDE CERTIFICATE

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ABSTRACT

Vibration causes cracks in PCBs which leads to short circuits and other problems. To avoid those problemsthe vibration analysis of electronic assemblies that consists of an electronic box, printed circuit board and electronic components is presented. A detailed vibration analysis of a real electronic assembly is performed by Analysis Software.

In this project, the distinctness of vibration analysis of electronic control unit box assembly with spring and screw supported printed circuit board with electronic components are considered. A comprehensive longitudinal vibration analysis of a real electronic control unit box assembly is performed in simply supported condition with respect to structural type and modal analysis. Effects of component addition, board mounting, component modeling are investigated in detail.

In order to identify the most efficient, reliable and suitable method three different types of electronic box assemblies are modeled to observe different dynamic characteristics. The validity of those model is computationally checked by comparing results with finite element solution depending on the type of problem, the natural frequency with which the system is vibrating. The maximum deflection of this model is solved by finite element solution using solver target as mechanical APDL in ANSYS software.



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CHAPTER 4

CONCLUSION

4.1 RESULTS AND DISCUSSION

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In this project, the vibration analyses of electronic devices are performed in considering environmental working conditions. First of all finite element modeling is performed in order to understand the vibratory behaviour of a selected electronic system consist of rectangular printed circuit board with simply supported and fixed edges is developed.

An electronic assembly composed of electronic box, printed circuit board and components are modeled using reliable commercial finite element software, ANSYS. Natural frequencies and mode shapes are obtained from these analyses.

Effect of design and mounting of the electronic box is investigated. Importance of box rigidity in terms of vibration transmission to the PCB is observed. The effects of cover in electronic box design are examined and the effect of cover mounting on the dynamics of the system is presented.

One of the most important issues in finite element modeling of printed circuit boards is defining boundary conditions. The identification of PCB edge condition is very critical to have a reliable solution. Another important issue about PCB vibrations is component addition. Depending on vibration modes of a PCB, the location of component may affect the dynamics of the PCB. Especially, addition of large and heavy components may after the dynamics, and therefore such cases should be analyzed in detail. Finite element solutions showed that attaching a component on a PCB decrease analyzed and increases stiffness of the board in that region.

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